

Shenzhen GB-Link Technology Co,. LTD *Http//www.GB-Link.com*

GB-XFP-BD-XXXX-60S 10Gb/s BIDI XFP 60km Transceiver

PRODUCT FEATURES

- Hot-pluggable XFP footprint
- Supports 9.95Gb/s to 11.3Gb/s bit rates
- XFI Loopback Mode
- 1270nm DFB laser and APD receiver for GB-XFP-BD-2733-60S

1330nm DFB laser and APD receiver for GB-XFP-BD-3327-60S

- RoHS-6 Compliant (lead-free)
- Power dissipation<3.5W
- Case operating temperature:0 °C~70°C
- Up to 60km transmission on SMF
- 2-wire interface with integrated Digital Diagnostic monitoring
- EEPROM with Serial ID Functionality
- Compliant with XFP MSA with LC connector

APPLICATIONS

- 10GBASE-BX 10.3125Gb/s Ethernet
- 10GBASE-BX 9.953Gb/s Ethernet
- SONET OC-192 &SDH STM I-64.1

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PRODUCT DESCRIPTION

GB-XFP-BD-XXXX-60S is hot pluggable 3.3V Small-Form-Factor transceiver module. It designed expressly for high-speed communication applications that require rates up to 11.3Gb/s, it designed to be compliant with XFP MSA. The module data link up to 60km in 9/125um single mode fiber.

I. Absolute Maximum Ratings

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Storage Temperature	Ts	-40	-	85	°C	
Storage Ambient Humidity	HA	5	-	95	%	
Operating Relative Humidity	RH	-	-	85	%	
Power Supply Voltage	VCC	-0.3	-	4	V	
Signal Input Voltage	VCC	Vcc-0.3	-	Vcc+0.3	V	

II. Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Case Operating Temperature	Tcase	0	-	70	°C	Without air flow
Power Supply Voltage	VCC	3.14	3.3	3.47	V	
Power Supply Current	ICC	-	-	600	mA	
Data Rate	BR	9.95	10.3125	11.3	Gbps	
Transmission Distance	TD	2	-	60	km	
Coupled fiber		Single mode fiber				

III. Optical Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Transmitter						
Average Launched Power	PO	0	-	5	dBm	
Average Launched Power(Laser Off)	POUT-OFF	-	-	-45	dBm	Note (1)
Contro Wayalanath Danga	3.0	1260	1270	1280	nm	XFBL-273396-60D
Centre Wavelength Range	λC	1320	1330	1340	nm	XFBL-332796-60D
Side mode suppression ratio	SMSR	30	-	-	dB	

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Spectrum Bandwidth(-20dB)	σ	-	-	1	nm	
Extinction Ratio	ER	3.5		-	dB	Note (2)
Output Eye Mask	Compliant	Compliant with IEEE 802.3ae requirements			Note (2)	
Receiver	,					
Input Optical Wavelength) INI	1320	1330	1340	nm	XFBL-273396-60D
	λIN	1260	1270	1280	nm	XFBL-332796-60D
Receiver Sensitivity in average	Psen	-	-	-22	dBm	Note (3)
Input Saturation Power (Overload)	PSAT	-6	-	-	dBm	Note (3)
LOS -Assert Power	PA	-38	-	-	dBm	
LOS -Deassert Power	PD	-	-	-23	dBm	
LOS -Hysteresis	PHys	0.5	-	4	dB	

Note:

- 1. The optical power is launched into SMF
- Measured with RPBS 2³1-1 test pattern @10.3125Gbs
 Measured with RPBS 2³1-1 test pattern @10.3125Gbs BER=<10⁻¹²

IV. **Electrical Interface Characteristics**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Total power supply current	Icc	-	-	600	mA	
Transmitter						
Differential Data Input Voltage	VDT	120	-	820	mVp-p	
Differential line input Impedance	RIN	85	100	115	Ohm	
Transmitter Fault Output-High	VFaultH	2.4	-	Vcc	V	
Transmitter Fault Output-Low	VFaultL	-0.3	-	0.8	V	
Transmitter Disable Voltage- High	VDisH	2	-	Vcc+0.3	V	
Transmitter Disable Voltage- low	VDisL	-0.3	-	0.8	V	
Receiver						
Differential Data Output Voltage	VDR	300	-	850	mVp-p	
Differential line Output Impedance	ROUT	80	100	120	Ohm	
Receiver LOS Pull up Resistor	RLOS	4.7	-	10	KOhm	
Data Output Rise/Fall time	tr/tf	20	-	-	ps	
LOS Output Voltage-High	VLOSH	2	-	Vcc	V	
LOS Output Voltage-Low	VLOSL	-0.3	-	0.4	V	

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V. Pin Assignment

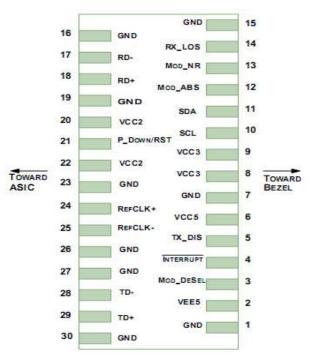


Diagram of Host Board Connector Block Pin Numbers and Name

Pin	Logic	Symbol	Name/Description	Note
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	



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2-wire serial interface commands LVTTL-O Interrupt
5 LVTTL-I TX_DIS Transmitter Disable; Transmitter laser source turned off 6 VCC5 +5 Power Supply 7 GND Module Ground 1 8 VCC3 +3.3V Power Supply 9 VCC3 +3.3V Power Supply 10 LVTTL-I SCL Serial 2-wire interface clock 2 11 LVTTLI/O SDA Serial 2-wire interface data line 2 12 LVTTL-O Mod_Abs Module Absent; Indicates module is not present. Grounded in the module. 13 LVTTL-O Mod_NR Module Not Ready; GB-LINK defines it as a logical OR between RX_LOS and Loss of Lock in TX/RX. 14 LVTTL-O RX_LOS Receiver Loss of Signal indicator 2
6 VCC5 +5 Power Supply 7 GND Module Ground 1 8 VCC3 +3.3V Power Supply 9 VCC3 +3.3V Power Supply 10 LVTTL-I SCL Serial 2-wire interface clock 2 11 LVTTL/O SDA Serial 2-wire interface data line 2 12 LVTTL-O Mod_Abs Module Absent; Indicates module is not present. Grounded in the module. 13 LVTTL-O Mod_NR Module Not Ready; GB-LINK defines it as a logical OR between RX_LOS and Loss of Lock in TX/RX. 14 LVTTL-O RX_LOS Receiver Loss of Signal indicator 2
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15 GND Module Ground 1
15 Wodale Ground
16 GND Module Ground 1
17 CML-O RD- Receiver inverted data output
18 CML-O RD+ Receiver non-inverted data output
19 GND Module Ground 1
20 VCC2 +1.8V Power Supply – Not required
Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset
Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.
22 VCC2 +1.8V Power Supply – Not required
23 GND Module Ground 1
24 PECL-I RefCLK+ Reference Clock non-inverted input, AC coupled on the host board – Not required 3
25 PECL-I RefCLK- Reference Clock inverted input, AC coupled on the host board – Not required 3
26 GND Module Ground 1
27 GND Module Ground 1
28 CML-I TD- Transmitter inverted data input
29 CML-I TD+ Transmitter non-inverted data input
30 GND Module Ground 1

Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- 2. Open collector; should be pulled up with 4.7k 10kohms on host board to a voltage between 3.15V and 3.6V.
- 3. A Reference Clock input is not required by the GB-XFP-BD-XXXX-60S. If present, it will be ignored.



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VI. Digital Diagnostic Functions

As defined by the XFP MSA, GB-LINK XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

It also provides a sophisticated system of alarm and warning flags, which may be used to alert end-users when particular operating parameters are outside of a factory-set normal range.

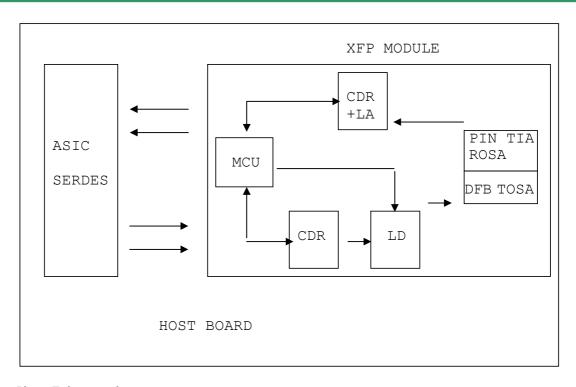
The operating and diagnostics information is monitored and reported by a Digital Diagnostics Transceiver Controller (DDTC) inside the transceiver, which is accessed through the 2-wire serial interface. When the serial protocol is activated, the serial clock signal (SCL pin) is generated by the host. The positive edge clocks data into the XFP transceiver into those segments of its memory map that are not write-protected. The negative edge clocks data from the XFP transceiver. The serial data signal (SDA pin) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially. The 2-wire serial interface provides sequential or random access to the 8 bit parameters, addressed from 000h to the maximum address of the memory.

For more detailed information including memory map definitions, please see the XFP MSA Specification.

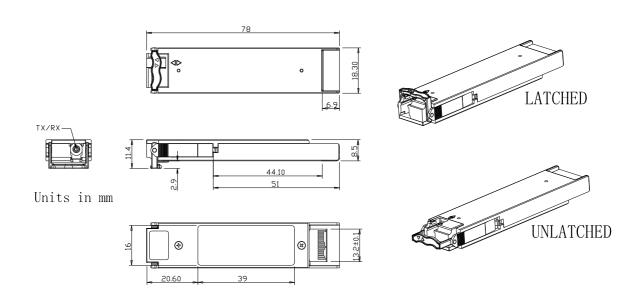
VII. Recommended Block Circuit



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VIII. Outline Dimensions





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IX. Regulatory Compliance

Feature	Reference	Performance
Electrostatic discharge (ESD)	IEC/EN 61000-4-2	Compatible with standards
Electromagnetic Interference (EMI)	FCC Part 15 Class B EN 55022 Class B (CISPR 22A)	Compatible with standards
Laser Eye Safety	FDA 21CFR 1040.10, 1040.11 IEC/EN 60825-1, 2	Class 1 laser product
Component Recognition	IEC/EN 60950 ,UL	Compatible with standards
ROHS	2002/95/EC	Compatible with standards
EMC	EN61000-3	Compatible with standards

Appendix A. Document Revision

Version No.	Date	Description
1.0	2010-09-01	Preliminary datasheet
2.0	2011-09-10	Update format and company's logo